

FDG327N Datasheet



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DiGi Electronics Part Number

FDG327N-DG

Manufacturer

onsemi

Manufacturer Product Number

FDG327N

Description

MOSFET N-CH 20V 1.5A SC88

Detailed Description

N-Channel 20 V 1.5A (Ta) 420mW (Ta) Surface Mou

nt SC-88 (SC-70-6)



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
FDG327N	onsemi
Series:	Product Status:
PowerTrench®	Obsolete
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
20 V	1.5A (Ta)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ Id, Vgs:
1.8V, 4.5V	90mOhm @ 1.5A, 4.5V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
1.5V @ 250µA	6.3 nC @ 4.5 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±8V	423 pF @ 10 V
FET Feature:	Power Dissipation (Max):
-	420mW (Ta)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
SC-88 (SC-70-6)	6-TSSOP, SC-88, SOT-363
Base Product Number:	
FDG327	

Environmental & Export classification

8541.21.0095

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	

MOSFET - N-Channel, POWERTRENCH® 20 V

FDG327N

General Description

This N–Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized use in small switching regulators, providing an extremely low $R_{DS(ON)}$ and gate charge (Q_G) in a small package.

Features

- 1.5 A, 20 V
 - $R_{DS(ON)} = 90 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
 - $R_{DS(ON)} = 100 \text{ m}\Omega @ V_{GS} = 2.5 \text{ V}$
 - $R_{DS(ON)} = 140 \text{ m}\Omega @ V_{GS} = 1.8 \text{ V}$
- Fast Switching Speed
- Low Gate Charge (4.5 nC Typical)
- High Performance Trench Technology for Extremely Low R_{DS(ON)}
- High Power and Current Handling Capability
- These Devices are Pb-Free and are RoHS Compliant

Applications

- DC/DC Converter
- Load Switch
- Power Management

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

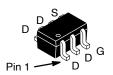
Symbol	Parameter	Ratings	Units	
V_{DSS}	Drain-Source Voltage		20	V
V_{GSS}	Gate-Source Voltage		±8	V
I _D	Drain Current Continuous (Note 1a)		1.5	Α
		Pulsed	6	
P_{D}	Power Dissipation for Single Operation	(Note 1a)	0.42	W
	Single Operation	(Note 1b)	0.38	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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SC-88/SC70-6/SOT-363 CASE 419B-02

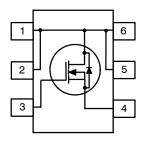
MARKING DIAGRAM



27 M = Specific Device Code

= Assembly Operation Month

PIN CONNECTIONS



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

THERMAL CHARACTERISTICS

Symbol	Parameter	Ratings	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	300	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1b)	333	°C/W

^{1.} $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a) 300° C/W when mounted on a 1 in² pad of 2 oz copper.



b) 333°C/W when mounted on a minimum pad of 2 oz copper..

PACKAGE MARKING AND ORDERING INFORMATION

Device Marking	Device	Reel Size	Tape Width	Shipping [†]
27	FDG327N	7"	8 mm	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20	-	-	V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C	_	12	-	mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 16 V, V _{GS} = 0 V	-	_	1	μΑ
I _{GSSF}	Gate-Body Leakage, Forward	V _{GS} = 8 V, V _{DS} = 0 V	-	-	100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = -8 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	-100	nA
ON CHARACTE	ERISTICS (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.4	0.7	1.5	V
$\Delta V_{GS(th)}$ / ΔT_J	Gate Threshold Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C	-	-3	-	mV/°C
R _{DS(on)}	Static Drain-Source On-Resistance	$\begin{aligned} &V_{GS} = 4.5 \text{ V}, I_D = 1.5 \text{ A} \\ &V_{GS} = 2.5 \text{ V}, I_D = 1.4 \text{ A} \\ &V_{GS} = 1.8 \text{ V}, I_D = 1.2 \text{ A} \\ &V_{GS} = 4.5 \text{ V}, I_D = 1.5 \text{ A}, T_J = 125^{\circ}\text{C} \end{aligned}$	- - -	57 66 82 72	90 100 140 115	mΩ
I _{D(on)}	On-State Drain Current	V _{GS} = 4.5 V, V _{DS} = 5 V	6	-	-	Α
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 1.5 A	-	9	-	S
OYNAMIC CHA	RACTERISTICS		-			
C _{iss}	Input Capacitance	V _{DS} = 10 V, V _{GS} = 0 V, f = 1.0 MHz	-	423	-	pF
C _{oss}	Output Capacitance	1	-	87	-	pF
C _{rss}	Reverse Transfer Capacitance	1	-	48	-	pF
SWITCHING CH	HARACTERISTICS (Note 2)					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 10 V, I _D = 1 A,	-	6	12	ns
t _r	Turn-On Rise Time	$V_{\rm GS}$ = 4.5 V, $R_{\rm GEN}$ = 6 Ω	-	6.5	13	ns
t _{d(off)}	Turn-Off Delay Time	1	-	14	29	ns
t _f	Turn-Off Fall Time	1	-	2	4	ns
Qg	Total Gate Charge	V _{DS} = 10 V, I _D = 1.5 A,	-	4.5	6.3	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 4.5 V	-	0.89	-	nC
Q_{gd}	Gate-Drain Charge		-	0.95	-	nC
DRAIN-SOURC	CE DIODE CHARACTERISTICS AND M	AXIMUM RATINGS				
Is	Maximum Continuous Drain-Source D	iode Forward Current	-	-	0.32	Α
V_{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 0.32 A (Note 2)	-	0.75	1.2	V
	1					•

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse Test: Pulse Width < 300 µs, Duty Cycle < 2.0%

TYPICAL PERFORMANCE CHARACTERISTICS

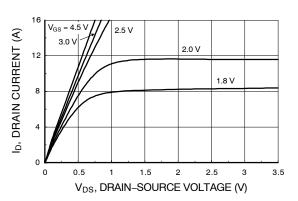


Figure 1. On-Region Characteristics

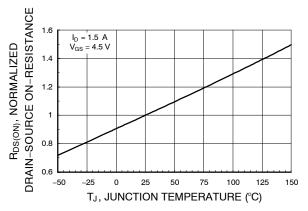


Figure 3. On–Resistance Variation with Temperature

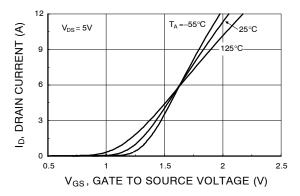


Figure 5. Transfer Characteristics

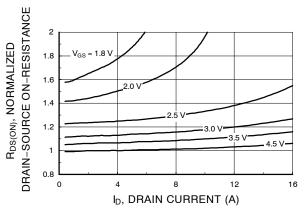


Figure 2. On–Resistance Variation with Drain Current and Gate Voltage

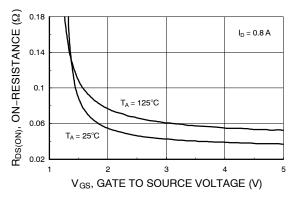


Figure 4. On–Resistance Variation with Gate–to–Source Voltage

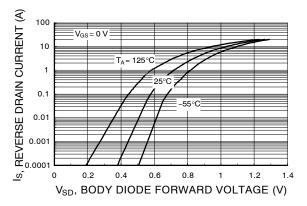


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

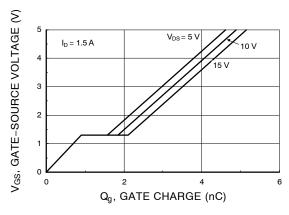


Figure 7. Gate Charge Characteristics

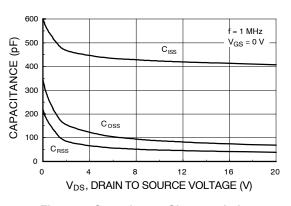


Figure 8. Capacitance Characteristics

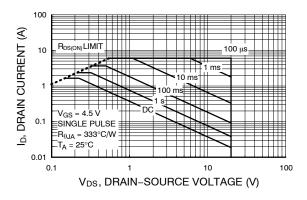


Figure 9. Maximum Safe Operating Area

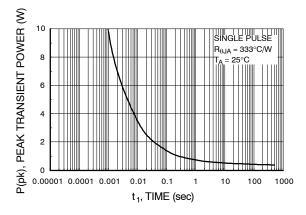
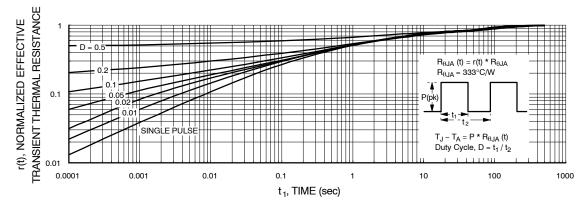


Figure 10. Single Pulse Maximum Power Dissipation



Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.

Figure 11. Transient Thermal Response Curve

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MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS



SC-88 2.00x1.25x0.90, 0.65P CASE 419B-02 **ISSUE Z**

DATE 18 APR 2024

MILLIMETERS

NOM

0.90

0.20

0.15

0.36

0.15

0.30

0.10

0.10

MAX.

1.10

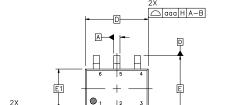
0.10

1.00

0.25

0.22

0.46



TOP VIEW

e

В

<u></u> БЬБ С

⊕ ddd M C A−B D

6X 0.66

NOTES:

- DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2018.
- ALL DIMENSION ARE IN MILLIMETERS.
- DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END.
- DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AND DATUM H.
 DATUMS A AND B ARE DETERMINED AT DATUM H.
- DIMENSIONS 6 AND c APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP. 6.
- DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION 6 AT MAXIMUM MATERIAL CONDITION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.

DIM

Α

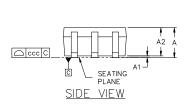
Α1

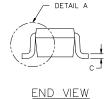
Α2

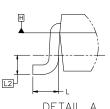
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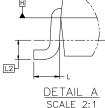
0.00

0.70









MARKING DIAGRAM*



XXX = Specific Device Code = Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)

- *Date Code orientation and/or position may vary depending upon manufacturing location.
- *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

2.50

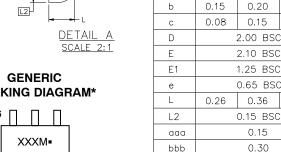
6X 0.30 -

RECOMMENDED MOUNTING FOOTPRINT*

STYLES ON PAGE 2

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DATE 18 APR 2024

STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 2: CANCELLED	STYLE 3: CANCELLED	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2
STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2	STYLE 8: CANCELLED	STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2	STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2	STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2	STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2
STYLE 13: PIN 1. ANODE 2. N/C 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 14: PIN 1. VREF 2. GND 3. GND 4. IOUT 5. VEN 6. VCC	STYLE 15: PIN 1. ANODE 1 2. ANODE 2 3. ANODE 3 4. CATHODE 3 5. CATHODE 2 6. CATHODE 1	STYLE 16: PIN 1. BASE 1 2. EMITTER 2 3. COLLECTOR 2 4. BASE 2 5. EMITTER 1 6. COLLECTOR 1	STYLE 17: PIN 1. BASE 1 2. EMITTER 1 3. COLLECTOR 2 4. BASE 2 5. EMITTER 2 6. COLLECTOR 1	STYLE 18: PIN 1. VIN1 2. VCC 3. VOUT2 4. VIN2 5. GND 6. VOUT1
STYLE 19: PIN 1. I OUT 2. GND 3. GND 4. V CC 5. V EN 6. V REF	STYLE 20: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. EMITTER 5. COLLECTOR 6. COLLECTOR	STYLE 21: PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. N/C 6. CATHODE 1	STYLE 22: PIN 1. D1 (i) 2. GND 3. D2 (i) 4. D2 (c) 5. VBUS 6. D1 (c)	STYLE 23: PIN 1. Vn 2. CH1 3. Vp 4. N/C 5. CH2 6. N/C	STYLE 24: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE
STYLE 25: PIN 1. BASE 1 2. CATHODE 3. COLLECTOR 2 4. BASE 2 5. EMITTER 6. COLLECTOR 1	STYLE 26: PIN 1. SOURCE 1 2. GATE 1 3. DRAIN 2 4. SOURCE 2 5. GATE 2 6. DRAIN 1	STYLE 27: PIN 1. BASE 2 2. BASE 1 3. COLLECTOR 1 4. EMITTER 1 5. EMITTER 2 6. COLLECTOR 2	STYLE 28: PIN 1. DRAIN 2. DRAIN 3. GATE 4. SOURCE 5. DRAIN 6. DRAIN	STYLE 29: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE/ANODE 6. CATHODE	STYLE 30: PIN 1. SOURCE 1 2. DRAIN 2 3. DRAIN 2 4. SOURCE 2 5. GATE 1 6. DRAIN 1

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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